IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No	09/059,057
Priority Filing Date	April 10, 1998
Inventor	. Vishnu K. Agarwal et al.
Assignee	. Micron Technology, Inc.
Priority Group Art Unit	2822
Priority Examiner	M. Guerrero
Attorney's Docket No	
Title: Capacitors and Methods of Forming Capacitors	F. A.

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

References -- See Attached Form PTO-1449

In compliance with 37 C.F.R. §1.56, 1.97 and 1.98, your attention is directed to the United States patents and other references listed on the attached Form PTO-1449. No admission is made regarding whether all the submitted references are prior art.

The listed references were cited by, or submitted to, the Office in the parent, co-pending application of the above-identified application. The above-identified application is a divisional application of co-pending application Serial No. 09/059,057, filed April 10, 1998. Such prior disclosure is sufficient for the above-identified application as far as copies of the references are concerned. 37 C.F.R. §1.98(d) and MPEP §609(2).

Citation of these references is respectfully requested.

Respectfully submitted,

Dated: 10-26-99

Mark S. Matkin Reg. No. 32,268

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VISHNU K. AGARWAL ET AL.

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